

General Description

The DS1089L is a clock generator that produces a spread-spectrum (dithered) square-wave output of frequencies from 130kHz to 66.6MHz. The DS1089L is shipped from the factory programmed at a specific frequency. The DS1089L is pin-for-pin compatible with the DS1087L, however, the DS1089L dithers at equal percentages above and below the center frequency. The user still has access to the internal frequency divider, selectable $\pm 1\%$, $\pm 2\%$, $\pm 4\%$, or $\pm 8\%$ dithered output, dithering rate, and programmable output power-down/disable mode through an I²C-compatible programming interface. All the device settings are stored in nonvolatile (NV) EEPROM allowing it to operate in stand-alone applications. The DS1089L also has power-down and output-enable control pins for power-sensitive applications.

Applications

- Printers
- Copiers
- Computer Peripherals
- POS Terminals
- Cable Modems

Pin Configuration and Typical Operating Circuits appear at end of data sheet.

Standard Frequency Options

| PART | FREQUENCY (MHz) | SPREAD ($\pm\%$) | DITHER FREQUENCY |
|--------------|------------------|--------------------|---------------------------------|
| DS1089LU-21G | 14.7456 | 1 | $f_{MOSC}/4096$ |
| DS1089LU-4CL | 18.432 | 2 | $f_{MOSC}/4096$ |
| DS1089LU-22F | 24.576 | 1 | $f_{MOSC}/2048$ |
| DS1089LU-23C | 33.3 | 1 | $f_{MOSC}/4096$ |
| DS1089LU-450 | 50.0 | 2 | $f_{MOSC}/4096$ |
| DS1089LU-866 | 66.6 | 4 | $f_{MOSC}/4096$ |
| DS1089LU-yxx | Fixed up to 66.6 | 1, 2, 4, or 8 | $f_{MOSC}/2048$ or 4096 or 8192 |

Add "T" for Tape and Reel.

Custom frequencies available, contact factory.

EconOscillator is a trademark of Maxim Integrated Products, Inc.

Features

- Factory-Programmed Square-Wave Generator from 33.3MHz to 66.6MHz
- Center Frequency Remains Constant Independent of Dither Percentage
- No External Timing Components Required
- EMI Reduction
- Variable Dither Frequency
- User Programmable Down to 130kHz with Divider (Dependent on Master Oscillator Frequency)
- $\pm 1\%$, $\pm 2\%$, $\pm 4\%$, or $\pm 8\%$ Selectable Dithered Output
- Glitchless Output-Enable Control
- I²C-Compatible Serial Interface
- Nonvolatile Settings
- Power-Down Mode
- Programmable Output Power-Down/Disable Mode

Ordering Information

| PART | TEMP RANGE | PIN-PACKAGE |
|---------------|----------------|-----------------------|
| DS1089LU-yxx* | -40°C to +85°C | 8 μ SOP (118 mil) |

*See Standard Frequency Options Table.

Absolute Maximum Ratings

Voltage on VCC Relative to Ground-0.5V to +6.0V
 Voltage on SPRD, PDN, OE, SDA,
 SCL Relative to Ground*-0.5V to (V_{CC} + 0.5V)
 Operating Temperature Range..... -40°C to +85°C

Programming Temperature Range0°C to +70°C
 Storage Temperature Range -55°C to +125°C
 Soldering Temperature See IPC/JEDEC J-STD-020A

*This voltage must not exceed 6.0V.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Recommended Operating Conditions

(T_A = -40°C to +85°C.)

| PARAMETER | SYMBOL | CONDITION | MIN | TYP | MAX | UNITS |
|---|-----------------|-----------|-----------------------|-----|-----------------------|-------|
| Supply Voltage | V _{CC} | (Note 1) | 2.7 | 3.3 | 3.6 | V |
| High-Level Input Voltage (SDA, SCL, SPRD, PDN, OE) | V _{IH} | | 0.7 x V _{CC} | | V _{CC} + 0.3 | V |
| Low-Level Input Voltage (SDA, SCL, SPRD, PDN, OE) | V _{IL} | | -0.3 | | 0.3 x V _{CC} | V |

DC Electrical Characteristics

(V_{CC} = +2.7V to +3.6V, T_A = -40°C to +85°C.)

| PARAMETER | SYMBOL | CONDITION | MIN | TYP | MAX | UNITS |
|---------------------------------|------------------|--|-----|-----|-----|-------|
| High-Level Output Voltage (OUT) | V _{OH} | I _{OH} = -4mA, V _{CC} = min | 2.4 | | | V |
| Low-Level Output Voltage (OUT) | V _{OL} | I _{OL} = 4mA | | | 0.4 | V |
| Low-Level Output Voltage (SDA) | V _{OL1} | 3mA sink current | | | 0.4 | V |
| | V _{OL2} | 6mA sink current | | | 0.6 | |
| High-Level Input Current | I _{IH} | V _{IH} = V _{CC} | | | 1 | μA |
| Low-Level Input Current | I _{IL} | V _{IL} = 0V | -1 | | | μA |
| Supply Current (Active) | I _{CC} | C _L = 15pF, f _{OUT} = f _{MOSCmax} | | | 12 | mA |
| Standby Current (Power-Down) | I _{CCQ} | Power-down mode | | | 10 | μA |

Master Oscillator Characteristics

($V_{CC} = +2.7V$ to $+3.6V$, $T_A = -40^\circ C$ to $+85^\circ C$.)

| PARAMETER | SYMBOL | CONDITION | | MIN | TYP | MAX | UNITS |
|--|------------------------------------|--|------------------------------------|-------|-----|-------------------|-------|
| Internal Master Oscillator Frequency | f_{MOSC} | | | 33.3 | | 66.6 | MHz |
| Master Oscillator Frequency Tolerance | $\frac{\Delta f_{MOSC}}{f_{MOSC}}$ | $V_{CC} = 3.3V$, $T_A = +25^\circ C$ (Notes 2, 10) | | -0.5 | | +0.5 | % |
| Voltage Frequency Variation | $\frac{\Delta f}{f_{MOSC}}$ | $T_A = +25^\circ C$ (Note 3) | | -0.75 | | +0.75 | % |
| Temperature Frequency Variation (Note 4) | $\frac{\Delta f}{f_{MOSC}}$ | $V_{CC} = 3.3V$, $f_{OUT} = f_{MOSCmax}$ | $T_A = 0^\circ C$ to $+85^\circ C$ | -0.75 | | +0.75 | % |
| | | | $T_A = -40^\circ C$ to $0^\circ C$ | -2.00 | | +0.75 | |
| Dither Frequency Range (Note 5) | | $J3 = J2 = GND$ | | | | ± 1 | % |
| | | $J3 = GND, J2 = V_{CC}$ | | | | ± 2 | |
| | | $J3 = V_{CC}, J2 = GND$ | | | | ± 4 | |
| | | $J3 = J2 = V_{CC}$ | | | | ± 8 | |
| Dither Frequency (Note 5) | f_{MOD} | $J1 = GND, J0 = V_{CC}$ | | | | $f_{MOSC} / 2048$ | Hz |
| | | $J1 = V_{CC}, J0 = GND$ | | | | $f_{MOSC} / 4096$ | |
| | | $J1 = J0 = V_{CC}$ | | | | $f_{MOSC} / 8192$ | |

AC Electrical Characteristics

($V_{CC} = +2.7V$ to $+3.6V$, $T_A = -40^\circ C$ to $+85^\circ C$.)

| PARAMETER | SYMBOL | CONDITION | MIN | TYP | MAX | UNITS |
|---|----------------------|-----------|-----|-----|-----|--------------|
| Frequency Stable After PRESCALER Change | | | | | 1 | Period |
| Power-Up Time | $t_{POR} + t_{STAB}$ | (Note 6) | | 40 | 200 | μs |
| Enable of OUT After Exiting Power-Down Mode | t_{STAB} | (Note 6) | | | 512 | clock cycles |
| OUT Disabled After Entering Power-Down Mode | t_{PDN} | | | 7 | | μs |
| Load Capacitance | C_L | | | 15 | 50 | pF |
| Output Duty Cycle (f_{OUT}) | | | | 50 | | % |

AC Electrical Characteristics—I²c Interface

(V_{CC} = +2.7V to +3.6V, T_A = -40°C to +85°C, unless otherwise noted. Timing referenced to V_{IL(MAX)} and V_{IH(MIN)}.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---|---------------------|------------|------------------------|-----|-----|-------|
| SCL Clock Frequency | f _{SCL} | (Note 7) | 0 | | 400 | kHz |
| Bus Free Time Between Stop and Start Conditions | t _{BUF} | | 1.3 | | | μs |
| Hold Time (Repeated) Start Condition | t _{HD:STA} | | 0.6 | | | μs |
| Low Period of SCL | t _{LOW} | | 1.3 | | | μs |
| High Period of SCL | t _{HIGH} | | 0.6 | | | μs |
| Data Hold Time | t _{HD:DAT} | | 0 | | 0.9 | μs |
| Data Setup Time | t _{SU:DAT} | | 100 | | | ns |
| Start Setup Time | t _{SU:STA} | | 0.6 | | | μs |
| SDA and SCL Rise Time | t _R | (Note 8) | 20 + 0.1C _B | | 300 | ns |
| SDA and SCL Fall Time | t _F | (Note 8) | 20 + 0.1C _B | | 300 | ns |
| Stop Setup Time | t _{SU:STO} | | 0.6 | | | μs |
| SDA and SCL Capacitive Loading | C _B | (Note 8) | | | 400 | pF |
| EEPROM Write Time | t _{WR} | (Note 9) | | 10 | 20 | ms |

Nonvolatile Memory Characteristics

(V_{CC} = +2.7V to +3.6V.)

| PARAMETER | SYMBOL | CONDITION | MIN | TYP | MAX | UNITS |
|-----------|--------|-----------|--------|-----|-----|-------|
| Writes | | +70°C | 10,000 | | | |

Note 1: All voltages are referenced to ground.

Note 2: This is the absolute accuracy of the master oscillator frequency at the default settings with spread disabled.

Note 3: This is the change that is observed in master oscillator frequency with changes in voltage at T_A = +25°C.

Note 4: This is the change that is observed in master oscillator frequency with changes in temperature at V_{CC} = 3.3V.

Note 5: The dither deviation of the master oscillator frequency is bidirectional and results in an output frequency centered at the undithered frequency.

Note 6: This indicates the time elapsed between power-up and the output becoming active. An on-chip delay is intentionally introduced to allow the oscillator to stabilize. t_{STAB} is equivalent to 512 master clock cycles and will depend on the programmed master oscillator frequency.

Note 7: Timing shown is for fast-mode (400kHz) operation. This device is also backward compatible with I²C standard-mode timing.

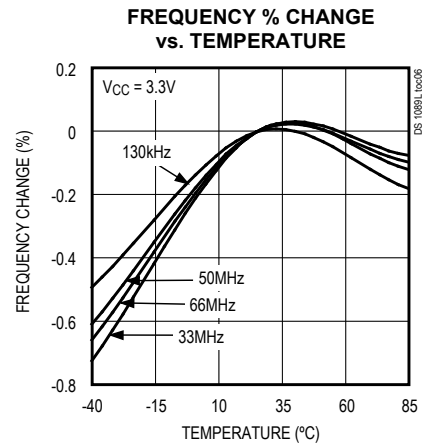
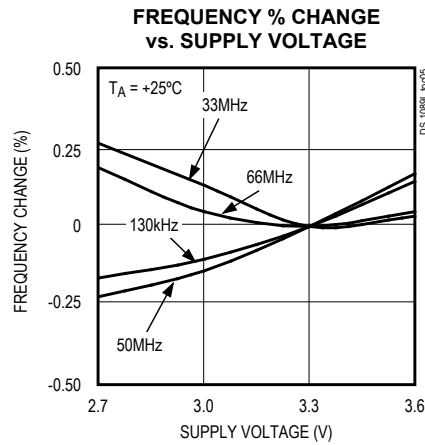
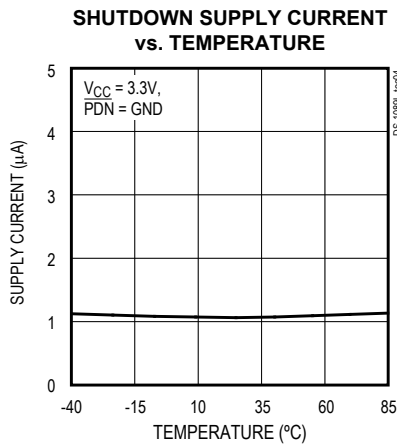
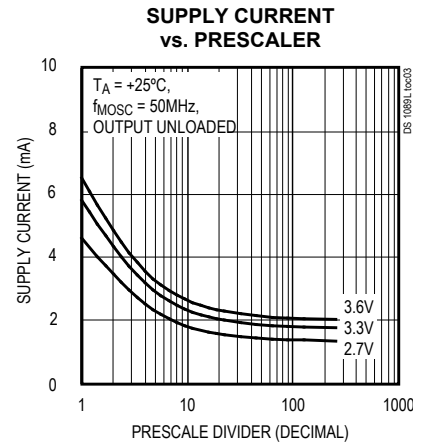
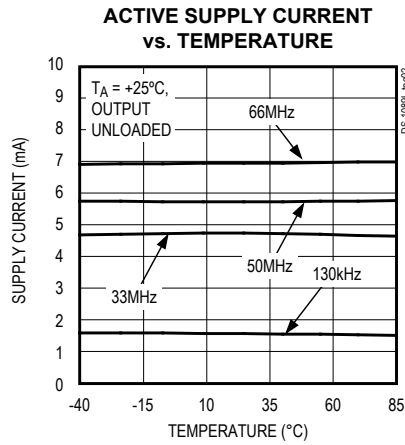
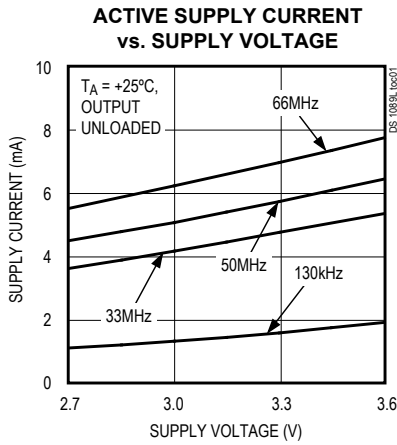
Note 8: C_B—total capacitance of one bus line in picofarads.

Note 9: EEPROM write time applies to all the EEPROM memory and SRAM shadowed EEPROM memory when WC = 0. The EEPROM write time begins after a stop condition occurs.

Note 10: Typical frequency shift due to aging is ±0.25%. Aging stressing includes Level 1 moisture reflow conditioning (24hr) +125°C bake, 168hr +85°C/85%RH moisture soak, and three solder reflow passes +269 +0/-5°C peak followed by 408hr max V_{CC} biased 125°C HTOL, 500 temperature cycles at -55°C to +125°C, 96hr +130°C/85%RH/3,6V HAST and 168hr +121°C/2 ATM Steam/Unbiased Autoclave.

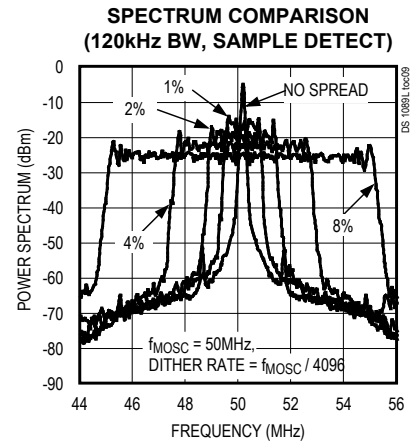
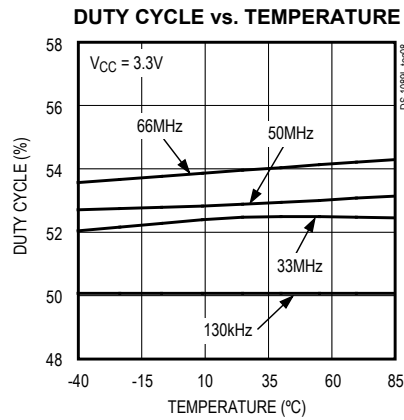
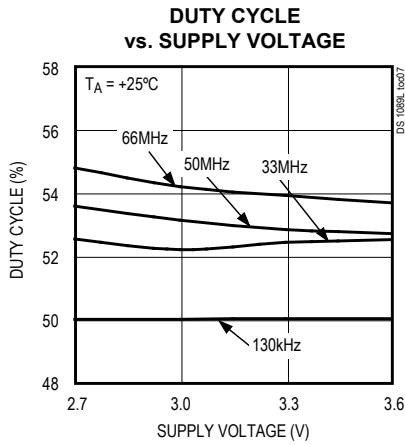
Typical Operating Characteristics

($V_{CC} = 3.3V$, $T_A = +25^\circ C$, unless otherwise noted.)



Typical Operating Characteristics (continued)

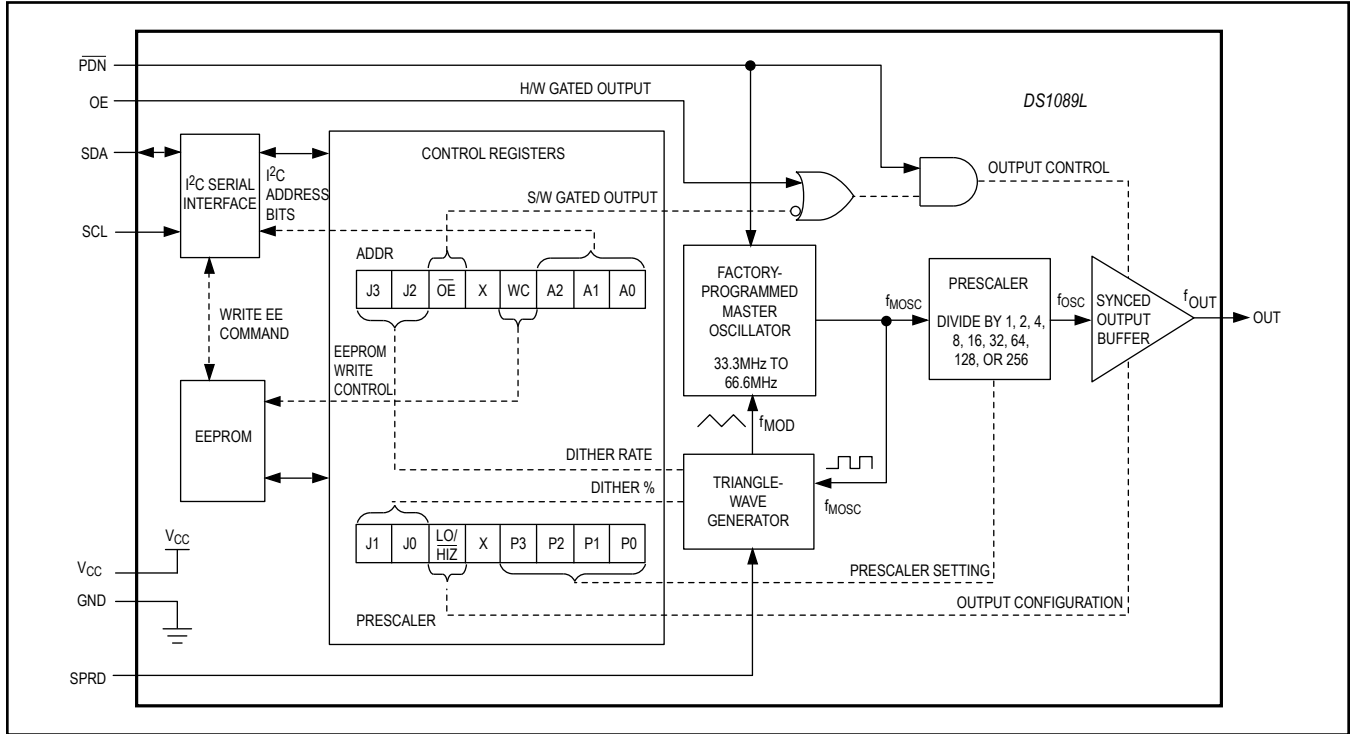
(V_{CC} = 3.3V, T_A = +25°C, unless otherwise noted.)



Pin Description

| PIN | NAME | FUNCTION |
|-----|-------------------------|--|
| 1 | OUT | Oscillator Output |
| 2 | SPRD | Dither Enable. When the pin is high, the dither is enabled. When the pin is low, the dither is disabled. |
| 3 | V _{CC} | Power Supply |
| 4 | GND | Ground |
| 5 | OE | Output Enable. When the pin is high, the output buffer is enabled. When the pin is low, the output is disabled but the internal master oscillator is still on. |
| 6 | $\overline{\text{PDN}}$ | Power-Down. When the pin is high, the master oscillator is enabled. When the pin is low, the master oscillator and the output buffer are disabled (power-down mode). |
| 7 | SDA | I ² C Serial Data. This pin is for serial data transfer to and from the device. |
| 8 | SCL | I ² C Serial Clock. This pin is used to clock data into and out of the device. |

Block Diagram



Detailed Description

Master Oscillator

The internal master oscillator is capable of generating a square wave with a 33.3MHz to 66.6MHz frequency range. The master oscillator frequency (f_{MOSC}) is factory programmed, and is specified in the *Ordering Information*.

Prescaler

The user can program the prescaler divider to produce an output frequency (f_{OUT}) as low as 130kHz using bits P0, P1, P2, and P3 in the PRESCALER register. The output frequency can be calculated using Equation 1. Any value programmed greater than 2^8 will be decoded as 2^8 . See Table 1 for prescaler divider settings.

Equation 1

$$\text{Output Frequency (Hz)} f_{OSC} = \frac{f_{MOSC}}{2^x}$$

where $x = P3, P2, P1, P0$

Table 1. Prescaler Divider Settings

| BITS P3, P2, P1, P0 | $2^x =$ | $f_{OUT} = f_{OSC}$ |
|---------------------|---------|---------------------|
| 0000 | 1 | f_{MOSC} |
| 0001 | 2 | $f_{MOSC} / 2$ |
| 0010 | 4 | $f_{MOSC} / 4$ |
| 0011 | 8 | $f_{MOSC} / 8$ |
| 0100 | 16 | $f_{MOSC} / 16$ |
| 0101 | 32 | $f_{MOSC} / 32$ |
| 0110 | 64 | $f_{MOSC} / 64$ |
| 0111 | 128 | $f_{MOSC} / 128$ |
| 1000 | 256 | $f_{MOSC} / 256$ |
| 1111 | 256 | $f_{MOSC} / 256$ |

Output Control

Two user control signals control the output. The output enable pin (OE) gates the output buffer and the power-down pin ($\overline{\text{PDN}}$) disables the master oscillator and turns off the output for power-sensitive applications. (**Note:** the power-down command must persist for at least two output frequency cycles plus 10 μ s for deglitching purposes.) On power-up, the output is disabled until power is stable and the master oscillator has generated 512 clock cycles.

Additionally, the OE input is OR'ed with the $\overline{\text{OE}}$ bit in the ADDR register, allowing for either hardware or software gating of the output waveform (see the *Block Diagram*).

Both controls feature a synchronous enable, which ensures that there are no output glitches when the output is enabled. The synchronous enable also ensures a constant time interval (for a given frequency setting) from an enable signal to the first output transition.

Dither Generator

The DS1089L has the ability to reduce radiated emission peaks. The output frequency can be dithered by $\pm 1\%$, $\pm 2\%$, $\pm 4\%$, or $\pm 8\%$ symmetrically around the programmed center frequency. Although the output frequency changes when the dither is enabled, the duty cycle does not change.

The dither rate (f_{MOD}) is controlled by the J0 and J1 bits in the PRESCALER register and is enabled with the SPRD pin. The maximum spectral attenuation occurs when the prescaler is set to 1. The spectral attenuation is reduced by 2.7dB for every factor of 2 that is used in the prescaler. This happens because the prescaler's divider function tends to average the dither in creating the lower frequency. However, the most stringent spectral emission limits are imposed on the higher frequencies where the prescaler is set to a low divider ratio.

A triangle-wave generator injects an offset element into the master oscillator to dither its output. The dither rate can be calculated based on the master oscillator frequency (see Equation 2).

Equation 2

$$f_{\text{MOD}} = \frac{f_{\text{MOSC}}}{n}$$

where f_{MOD} = dither frequency, f_{MOSC} = master oscillator frequency, and n = divider setting (see Table 2).

Dither Percentage Settings

The dither amplitude (measured in percentage of the master oscillator center frequency) is set using the J2 and J3 bits in the ADDR register. This circuit uses a sense current from the master oscillator bias circuit to adjust the amplitude of the triangle-wave signal to a voltage level that modulates the master oscillator to a percentage of its factory-programmed center frequency. This percentage is set in the application to be $\pm 1\%$, $\pm 2\%$, $\pm 4\%$, or $\pm 8\%$ (see Table 3).

The location of bits P3, P2, P1, P0, J1, and J0 in the PRESCALER register and bits J3 and J2 in the ADDR register are shown in the *Register Summary* section.

Table 2. Dither Frequency Settings

| BITS J1, J0 | DITHER FREQUENCY |
|-------------|------------------------|
| 00 | No dither |
| 01 | $f_{\text{MOSC}}/2048$ |
| 10 | $f_{\text{MOSC}}/4096$ |
| 11 | $f_{\text{MOSC}}/8192$ |

Table 3. Dither Percentage Settings

| BITS J3, J2 | DITHER AMOUNT |
|-------------|---------------|
| 00 | $\pm 1\%$ |
| 01 | $\pm 2\%$ |
| 10 | $\pm 4\%$ |
| 11 | $\pm 8\%$ |

When dither is enabled (by selecting a dither frequency setting greater than 0 with SPRD high), the master oscillator frequency is dithered around the center frequency by the selected percentage from the programmed f_{MOSC} (see Figure 2). For example, if f_{MOSC} is programmed to 40MHz (factory setting) and the dither amount is programmed to $\pm 1\%$, the frequency of f_{MOSC} will dither between 39.6MHz and 40.4MHz at a modulation frequency determined by the selected dither frequency. Continuing with the same example, if $J1 = 0$ and $J0 = 1$, selecting $f_{MOSC}/2048$, then the dither frequency would be 19.531kHz.

Register Summary

The DS1089L registers are used to change the dither amount, output frequency, and slave address. A bit summary of the registers is shown in Table 4. Once programmed into EEPROM, the settings only need to be reprogrammed if it is desired to reconfigure the device.

PRESCALER Register

Bits 7 to 6: **Dither Frequency.** The $J1$ and $J0$ bits control the dither frequency applied to the output. See Table 2 for divider settings. If either of bits $J1$ or $J0$ is high and $SPRD$ is high, dither is enabled.

Bit 5: **Output Low or Hi-Z.** The LO/HIZ bit determines the state of the output during power-down. While the output is deactivated, if the LO/HIZ bit is set to 0, the output will be high impedance (high-Z). If the LO/HIZ bit is set to 1, the output will be driven low.

Bit 4: **Reserved.**

Bits 3 to 0: **Prescaler Divider.** The prescaler bits (bits $P3$ to $P0$) divide the master oscillator frequency by 2^x where x can be from 0 to 8. Any prescaler bit value entered that is greater than 8 will decode as 8. See Table 1 for prescaler settings.

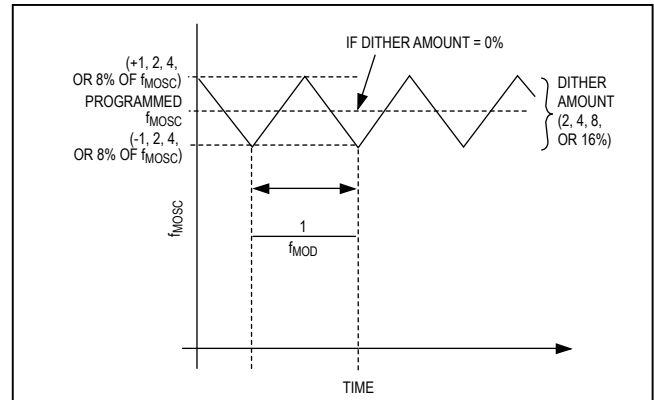


Figure 2. Output Frequency vs. Dither Rate

ADDR Register

Bits 7 to 6: **Dither Percentage.** The $J3$ and $J2$ bits control the selected dither amplitude (%). When both $J3$ and $J2$ are set to 0, the default dither rate is $\pm 1\%$.

Bit 5: **Output Enable.** The \overline{OE} bit and the OE pin state determine if the output is on when the device is active ($PDN = V_{IH}$). If ($OE = 0$ OR \overline{OE} is high) AND the PDN pin is high, the output will be driven.

Bit 4: **Reserved.**

Bit 3: **Write Control.** The WC bit determines if the EEPROM is to be written after register contents have been changed. If $WC = 0$ (default), EEPROM is written automatically after a write. If $WC = 1$, the EEPROM is only written when the $WRITE EE$ command is issued. See the *WRITE EE* Command section for more information.

Bits 2 to 0: **Address.** The $A0, A1, A2$ bits determine the lower nibble of the I^2C slave address.

Table 4. Register Summary

| REGISTER | ADDR | BIT7 | BINARY | | | | | | | BIT0 | DEFAULT | ACCESS |
|-----------|------|---------|--------|-----------------|---|----|----|----|----|-----------|---------|--------|
| PRESCALER | 02h | J1 | J0 | LO/HIZ | X | P3 | P2 | P1 | P0 | xx00xxxxb | R/W | |
| ADDR | 0Dh | J3 | J2 | \overline{OE} | X | WC | A2 | A1 | A0 | xx100000b | R/W | |
| WRITE EE | 3Fh | No Data | | | | | | | | — | — | |

X = "don't care"

x = values depend on custom settings

WRITE EE Command

The WRITE EE command is useful in closed-loop applications where the registers are frequently written. In applications where the register contents are frequently written, the WC bit should be set to 1 to prevent wearing out the EEPROM. Regardless of the value of the WC

bit, the value of the ADDR register is always written immediately to EEPROM. When the WRITE EE command has been received, the contents of the registers are written into the EEPROM, thus locking in the register settings.

I²C Serial Port Operation

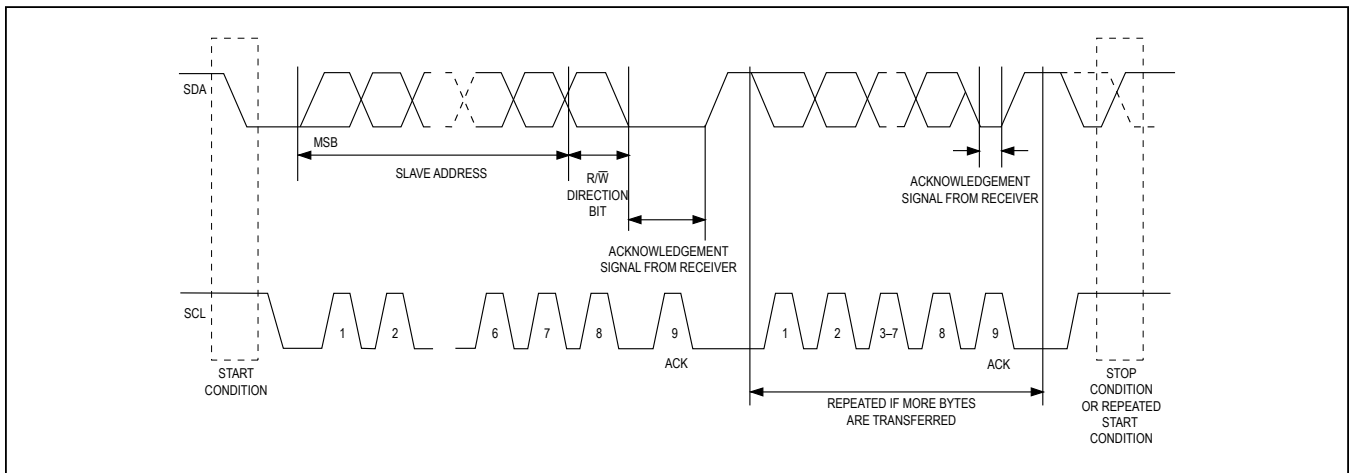


Figure 3. I²C Data Transfer Protocol

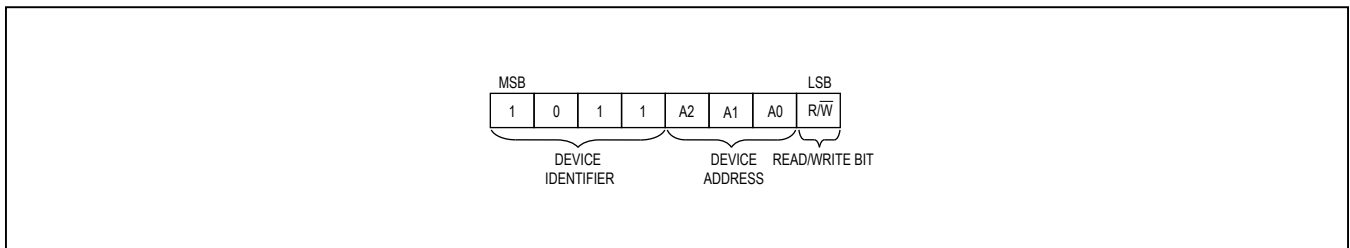


Figure 4. Slave Address Byte

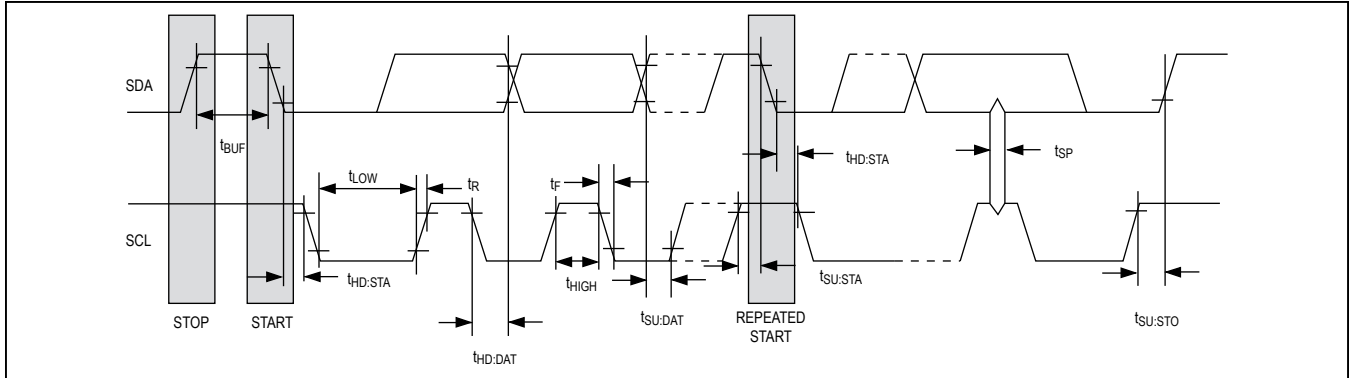


Figure 5. I²C AC Characteristics

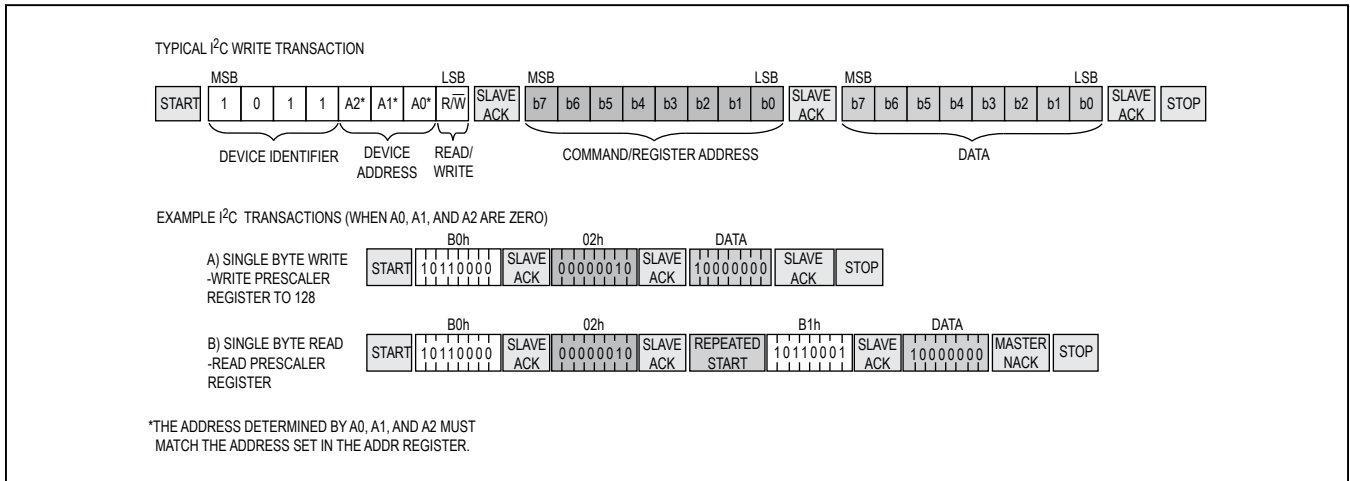


Figure 6. I²C Transactions

Applications Information

Power-Supply Decoupling

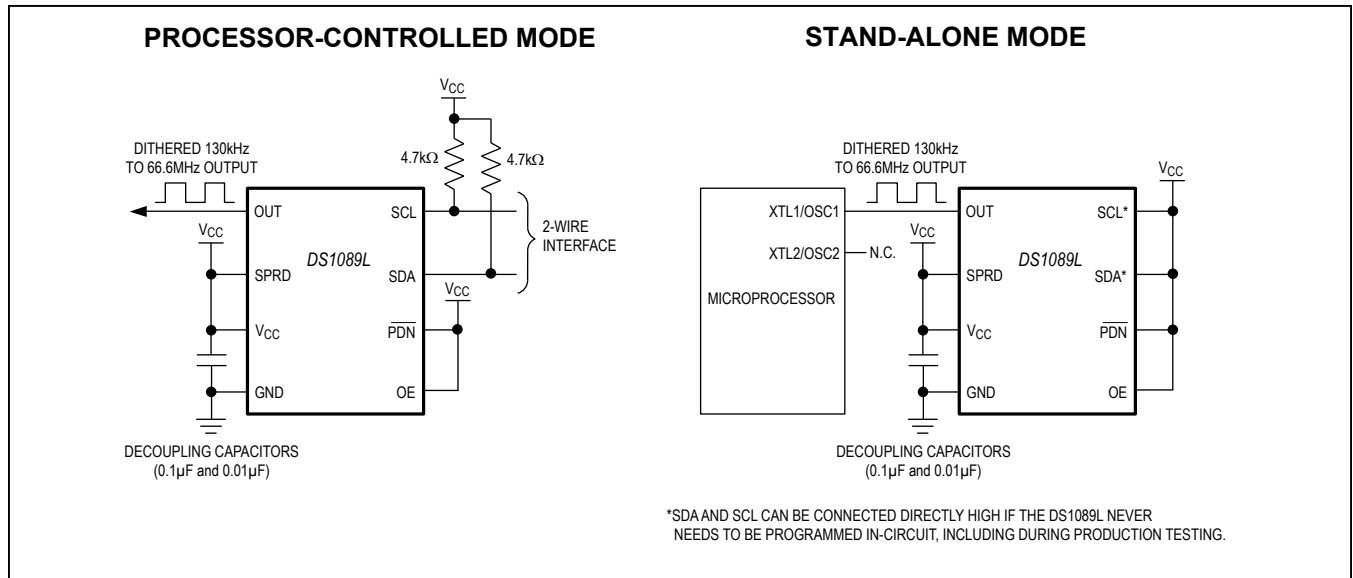
To achieve the best results when using the DS1089L, decouple the power supply with 0.01μF and 0.1μF high-quality, ceramic, surface-mount capacitors. Surface-mount components minimize lead inductance, which improves performance, and ceramic capacitors

tend to have adequate high-frequency response for decoupling applications. These capacitors should be placed as close to the V_{CC} and GND pins as possible.

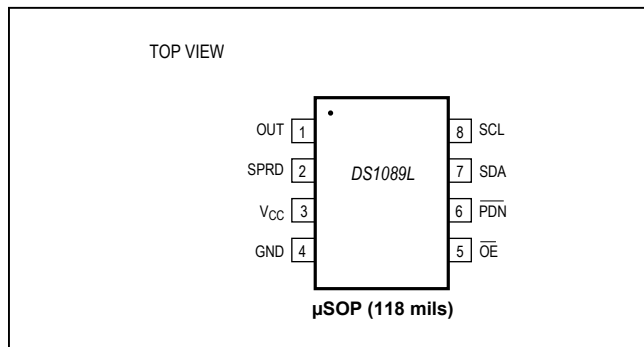
Stand-Alone Mode

SCL and SDA cannot be left floating even in stand-alone mode. If the DS1089L will never need to be programmed in-circuit, including during production testing, SDA and SCL can be connected high.

Typical Operating Circuits



Pin Configuration



Chip Topology

TRANSISTOR COUNT: 5985

SUBSTRATE CONNECTED TO GROUND

Package Information

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a “+”, “#”, or “-” in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Revision History

| REVISION NUMBER | REVISION DATE | DESCRIPTION | PAGES CHANGED |
|-----------------|---------------|--|---------------|
| 2 | 5/06 | | — |
| 3 | 2/15 | Removed automotive reference from data sheet | 1 |

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim Integrated's website at www.maximintegrated.com.

Maxim Integrated cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim Integrated product. No circuit patent licenses are implied. Maxim Integrated reserves the right to change the circuitry and specifications without notice at any time. The parametric values (min and max limits) shown in the Electrical Characteristics table are guaranteed. Other parametric values quoted in this data sheet are provided for guidance.



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.